Inolux Technologies 0.40” Dual Digit Numeric Display
HNTD40 Series

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DISCLAIMER

- The information contained herein is presented only as a guide for the applications of our products.

  No responsibility is assumed by INOLUX for any infringements of intellectual property or other rights of the third parties which may result from it use.
- Inolux is continually effort to improve the quality of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing INOLUX products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such INOLUX products cause loss of human life, bodily injury or damage to property.
- The INOLUX products listed in this document are intended for usage in general electronics (computer, personal equipment, office equipment, industrial robotics, domestic, etc…) These products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury.
- In developing your designs, please ensure that INOLUX products are used within specified operating ranges as set forth in the most recent INOLUX products specifications.
- Also, please keep in mind the precautions listed in this document.

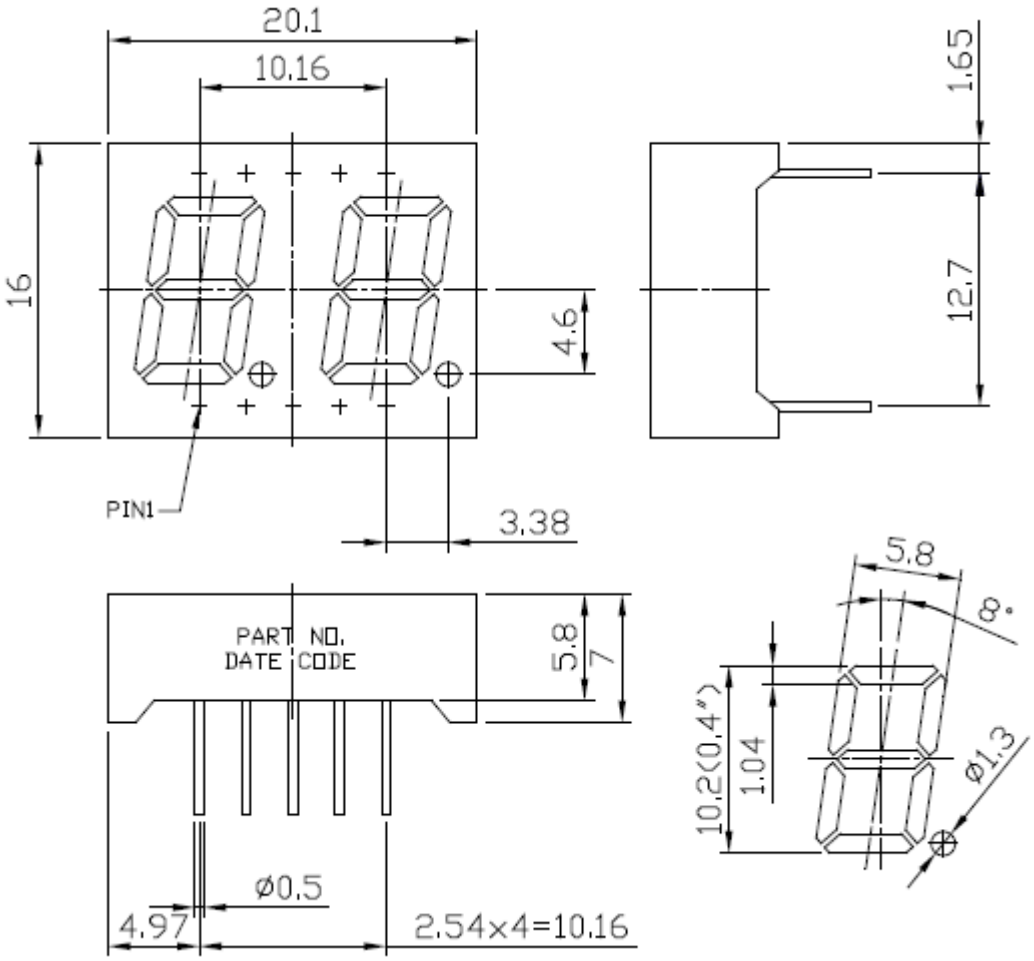
Orderable Information

H N T D 40 X X X - X X X X

Series Name	Digit Height	Color Code	Polarity	Customer Code
HNTD H: Inolux Technologies N: Numeric T: Through Hole D: Dual digit	**40:** 0.40” digit height	**UB:** 470nm InGaN Blue **UTG:** 525nm InGaN True Green **UYG:** 570nm AllnGaP Yellow Green **UY:** 590nm AllnGaP Yellow **UA:** 606nm AllnGaP Amber **UR:** 625nm AllnGaP Hyper Red **USR:** 639nm AllnGaP Super Red	**CA:** Common Anode **CC:** Common Cathode	**XXXX:** Customer specific code

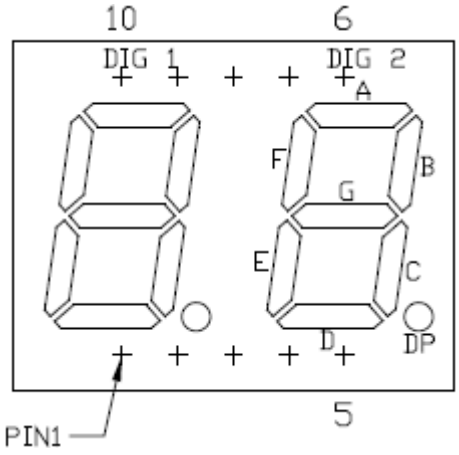
Features

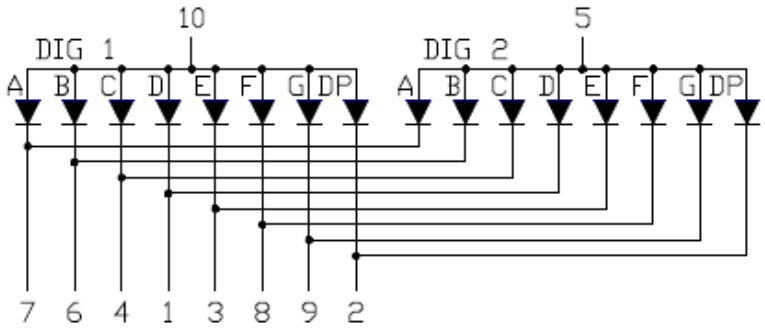
- 0.4” (10.2mm) Digit Height
- Through Hole Display
- Black Face , White Segment
- RoHS Compliant, Pb Free



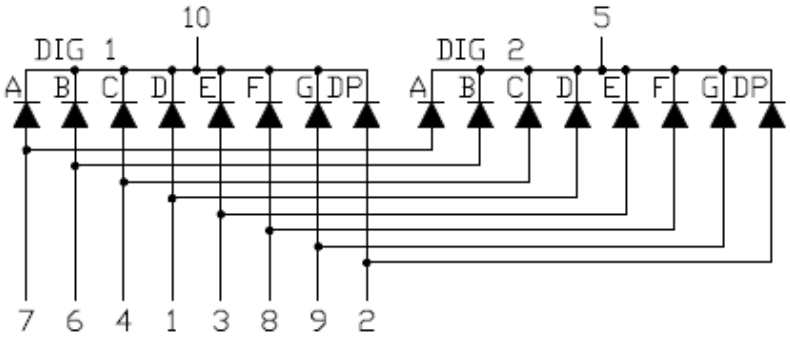
Note: Dimension is in millimeters. Tolerance is ±0.25mm unless otherwise noted.

Schematic Drawing





Common Anode



Common Cathode

Product Characteristic

Absolute Maximum Rating

(T_a= 25°C)

Product	Emission Color	P_{AD} (mW)	I_{AF} (mA)	I_{PF} (mA)	V_R (V)	T_{OP}(°C)	T_{ST}(°C)	Derate From 25°C (mA/°C)
HNTD40UBCA/ HNTD40UBCC	Blue	120	30	100	5	-25 ~ +85	-25 ~ +85	0.4
HNTD40UTGA/ HNTD40UTGC	True Green	120	30	100	5	-25 ~ +85	-25 ~ +85	0.3
HNTD40UYGA/ HNTD40UYGC	Yellow Green	85	30	120	5	-25 ~ +85	-25~ +85	0.42
HNTD40UYA/ HNTD40UYC	Yellow	70	25	90	5	-25 ~ +85	-25 ~ +85	0.28
HNTD40UAA/ HNTD40UAC	Amber	70	25	90	5	-25 ~ +85	+25 ~ +85	0.33
HNTD40URA/ HNTD40URC	Hyper Red	70	25	90	5	-25 ~ +85	-25 ~ +85	0.33
HNTD40USRA/ HNTD40USRC	Super Red	70	25	90	5	-25 ~ +85	-25 ~ +85	0.33

Electrical and Optical Characteristic

(T_a= 25°C)

Product	Emission Color	I_F (mA)	V_F (V)		λ (nm)		I_V (mcd)	I_R (μA)
			Typ.	Max.	λd	Δλ	Typ.	Max
HNTD40UBCA/ HNTD40UBCC	Blue	20	3.2	4.0	470	30	60	10 (V_R=8V)
HNTD40UTGA/ HNTD40UTGC	True Green	20	3.2	4.0	525	30	140	10 (V_R=8V)
HNTD40UYGA/ HNTD40UYGC	Yellow Green	20	2.1	2.6	571	20	20	10 (V_R=5V)
HNTD40UYA/ HNTD40UYC	Yellow	20	2.0	2.6	590	20	40	10 (V_R=5V)
HNTD40UAA/ HNTD40UAC	Amber	20	2.0	2.6	606	35	40	10 (V_R=5V)
HNTD40URA/ HNTD40URC	Hyper Red	20	2.0	2.6	625	20	40	10 (V_R=5V)
HNTD40USRA/ HNTD40USRC	Super Red	20	2.0	2.6	639	20	30	10 (V_R=5V)

Luminous Intensity tolerance = +/- 15%

Characteristic Curves for UB

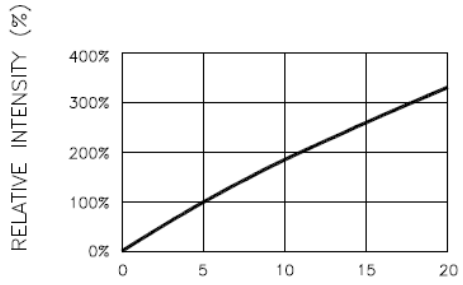


Fig.1 RELATIVE INTENSITY VS. FORWARD CURRENT

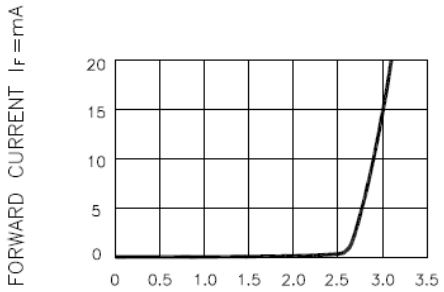


Fig.2 FORWARD CURRENT VS. FORWARD VOLTAGE

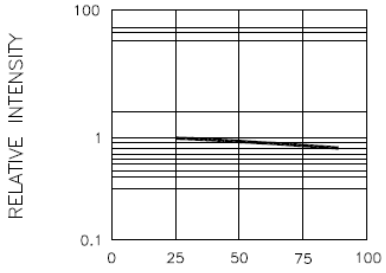


Fig.3 RELATIVE INTENSITY VS.LEAD TEMPERATURE
(PULSED 20 mA; 300us PULSE,10ms PERIOD)

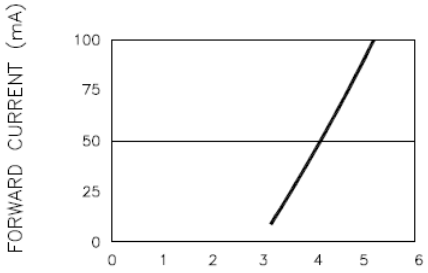


Fig.4 PEAK FORWARD VOLTAGE VS.FORWARD
(100us TEST PULSE, 1% DUTY CYCLE)

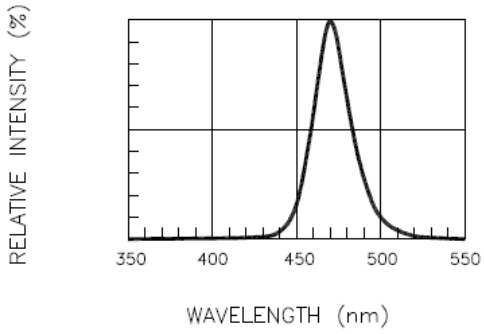


Fig.5 RELATIVE INTENSITY VS. WAVELENGTH

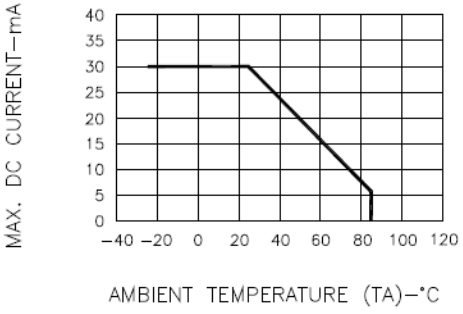


Fig.6 MAX. ALLOWABLE DC CURRENT
VS. AMBIENT TEMPERATURE

Characteristic Curves for UTG

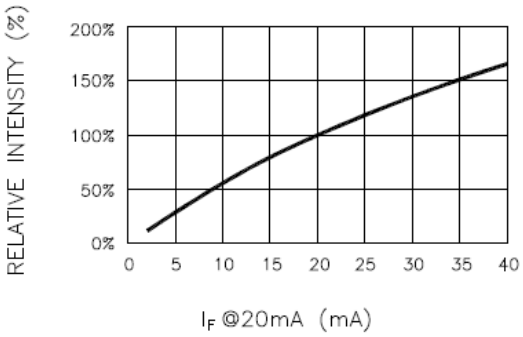


Fig.1 RELATIVE INTENSITY VS. FORWARD CURRENT

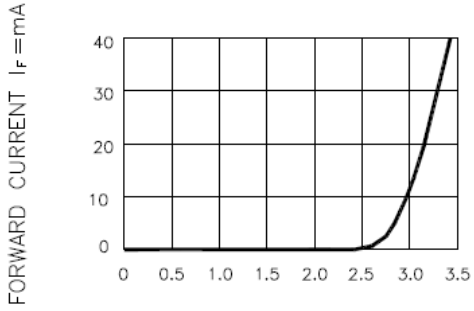


Fig.2 FORWARD CURRENT VS. FORWARD VOLTAGE

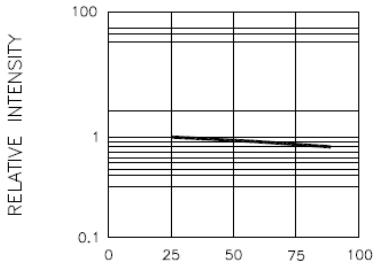


Fig.3 RELATIVE INTENSITY VS.LEAD TEMPERATURE
(PULSED 20 mA; 300us PULSE,10ms PERIOD)

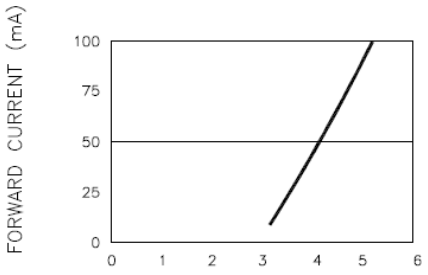


Fig.4 PEAK FORWARD VOLTAGE VS.FORWARD
(100us TEST PULSE, 1% DUTY CYCLE)

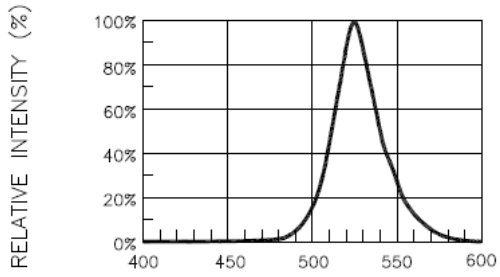


Fig.5 RELATIVE INTENSITY VS. WAVELENGTH

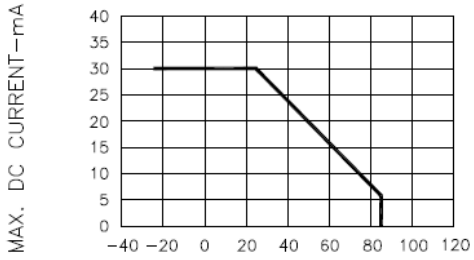


Fig.6 MAX. ALLOWABLE DC CURRENT
VS. AMBIENT TEMPERATURE

Characteristic Curves for UYG

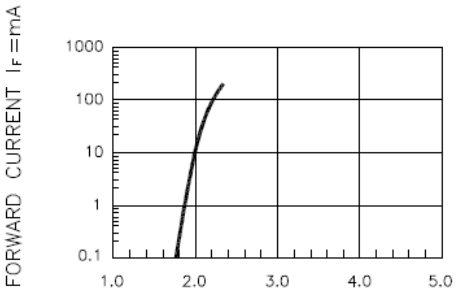


Fig.1 FORWARD CURRENT VS. FORWARD VOLTAGE

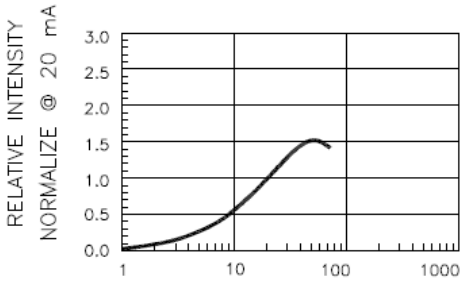


Fig.2 RELATIVE INTENSITY VS. FORWARD CURRENT

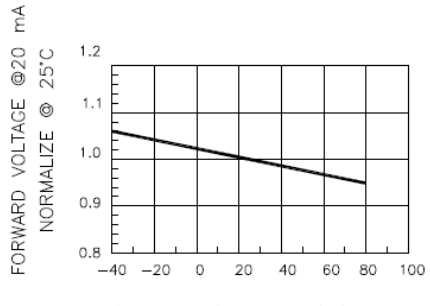


Fig.3 FORWARD VOLTAGE VS. TEMPERATURE

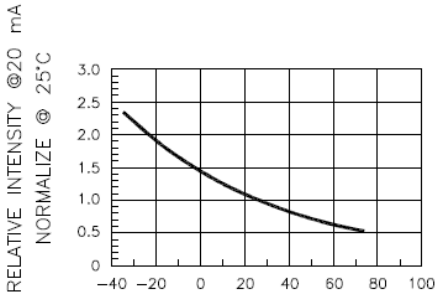


Fig.4 RELATIVE INTENSITY VS. TEMPERATURE

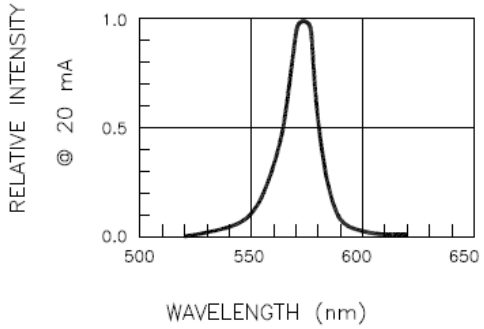


Fig.5 RELATIVE INTENSITY VS. WAVELENGTH

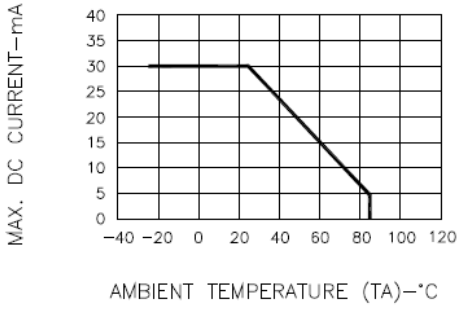


Fig.6 MAX. ALLOWABLE DC CURRENT VS. AMBIENT TEMPERATURE

Characteristic Curves for UY

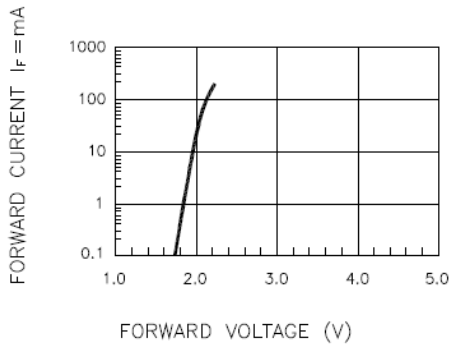


Fig.1 FORWARD CURRENT VS. FORWARD VOLTAGE

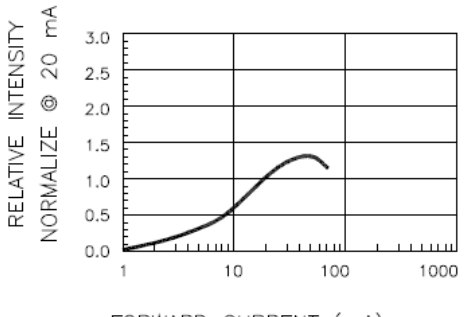


Fig.2 RELATIVE INTENSITY VS. FORWARD CURRENT

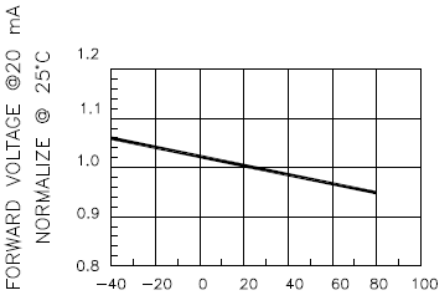


Fig.3 FORWARD VOLTAGE VS. TEMPERATURE

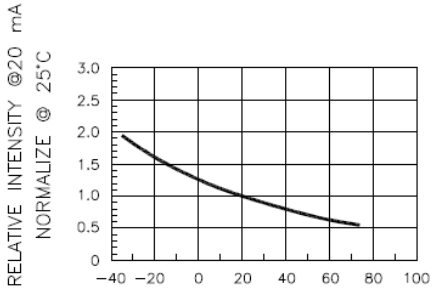


Fig.4 RELATIVE INTENSITY VS. TEMPERATURE

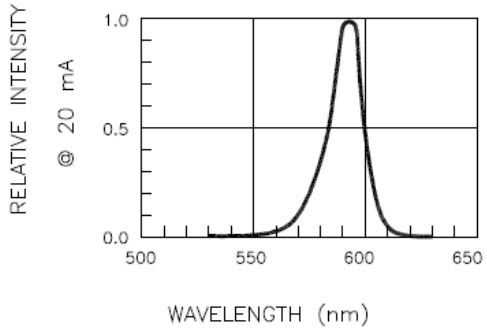


Fig.5 RELATIVE INTENSITY VS. WAVELENGTH

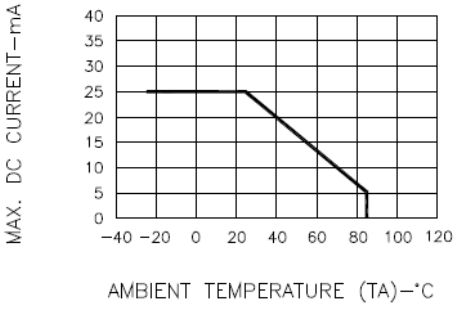


Fig.6 MAX. ALLOWABLE DC CURRENT VS. AMBIENT TEMPERATURE

Characteristic Curves for UA

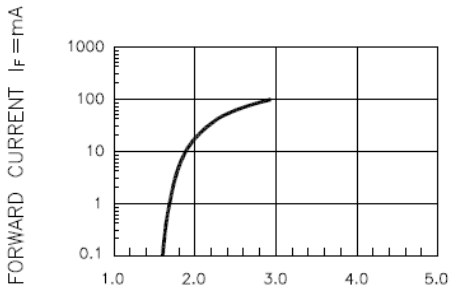


Fig.1 FORWARD CURRENT VS. FORWARD VOLTAGE

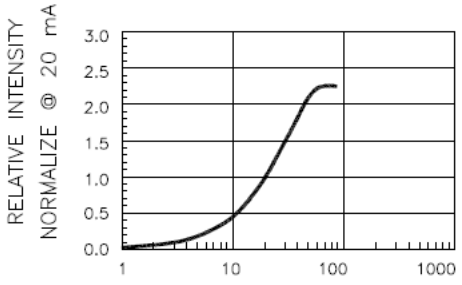


Fig.2 RELATIVE INTENSITY VS. FORWARD CURRENT

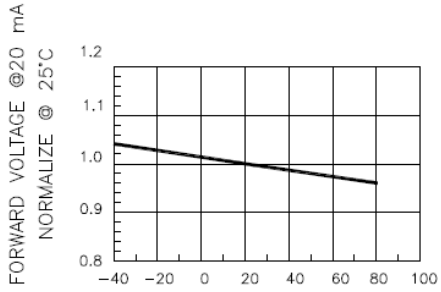


Fig.3 FORWARD VOLTAGE VS. TEMPERATURE

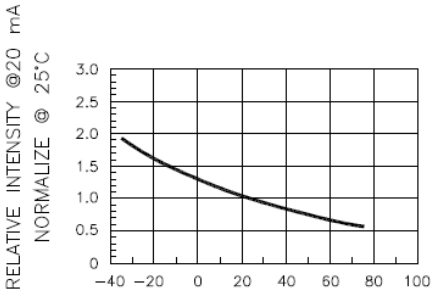


Fig.4 RELATIVE INTENSITY VS. TEMPERATURE

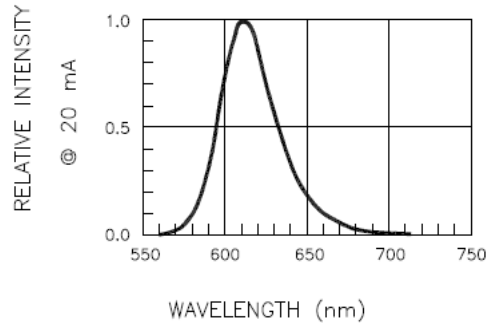


Fig.5 RELATIVE INTENSITY VS. WAVELENGTH

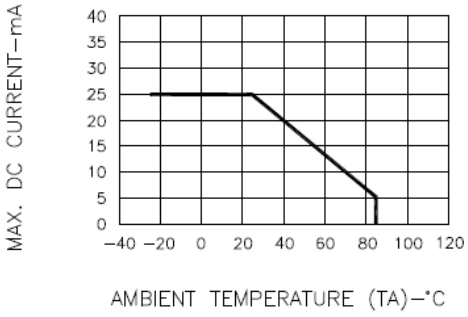


Fig.6 MAX. ALLOWABLE DC CURRENT VS. AMBIENT TEMPERATURE

Characteristic Curves for UR

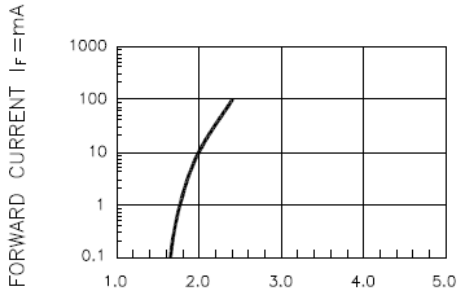


Fig.1 FORWARD CURRENT VS. FORWARD VOLTAGE

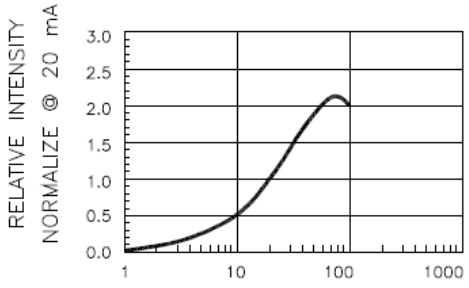


Fig.2 RELATIVE INTENSITY VS. FORWARD CURRENT

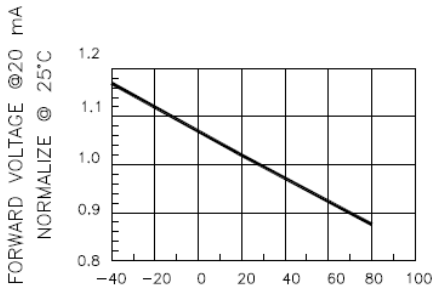


Fig.3 FORWARD VOLTAGE VS. TEMPERATURE

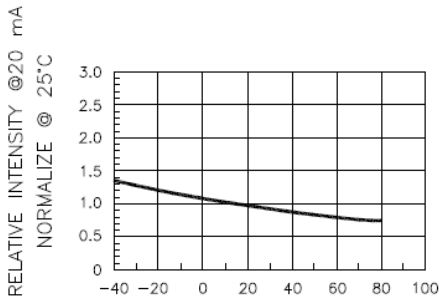


Fig.4 RELATIVE INTENSITY VS. TEMPERATURE

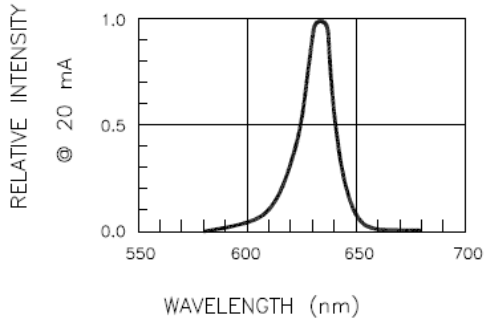


Fig.5 RELATIVE INTENSITY VS. WAVELENGTH

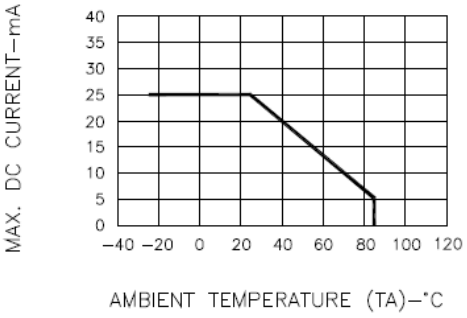


Fig.6 MAX. ALLOWABLE DC CURRENT VS. AMBIENT TEMPERATURE

Characteristic Curves for USR

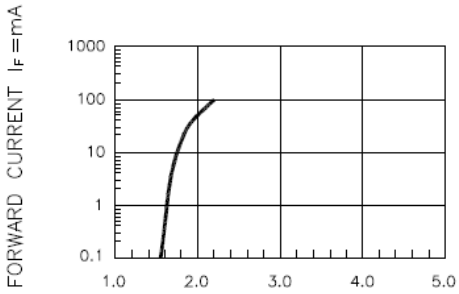


Fig.1 FORWARD CURRENT VS. FORWARD VOLTAGE

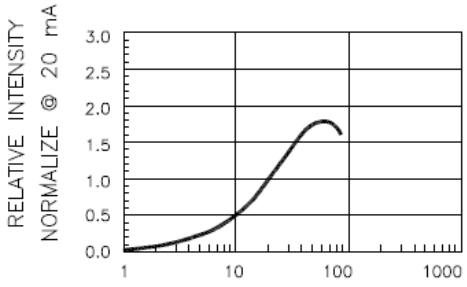


Fig.2 RELATIVE INTENSITY VS. FORWARD CURRENT

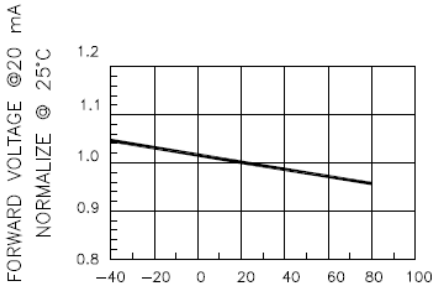


Fig.3 FORWARD VOLTAGE VS. TEMPERATURE

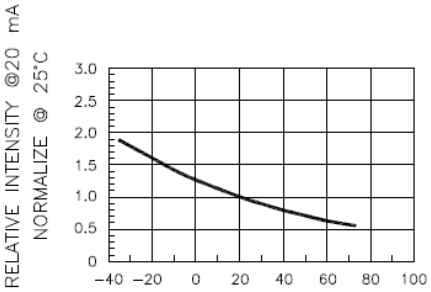


Fig.4 RELATIVE INTENSITY VS. TEMPERATURE

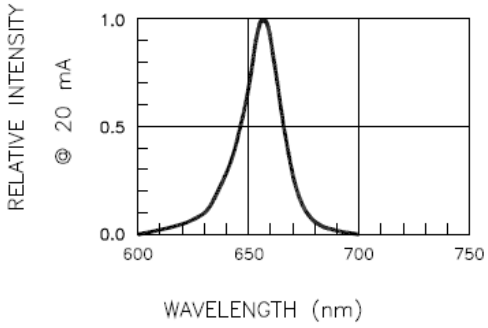


Fig.5 RELATIVE INTENSITY VS. WAVELENGTH

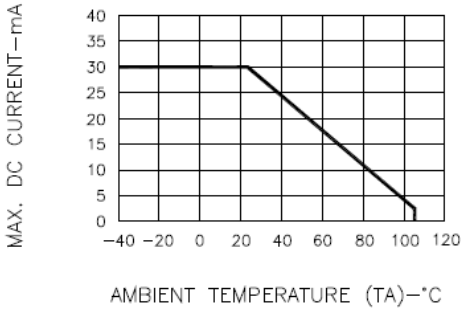
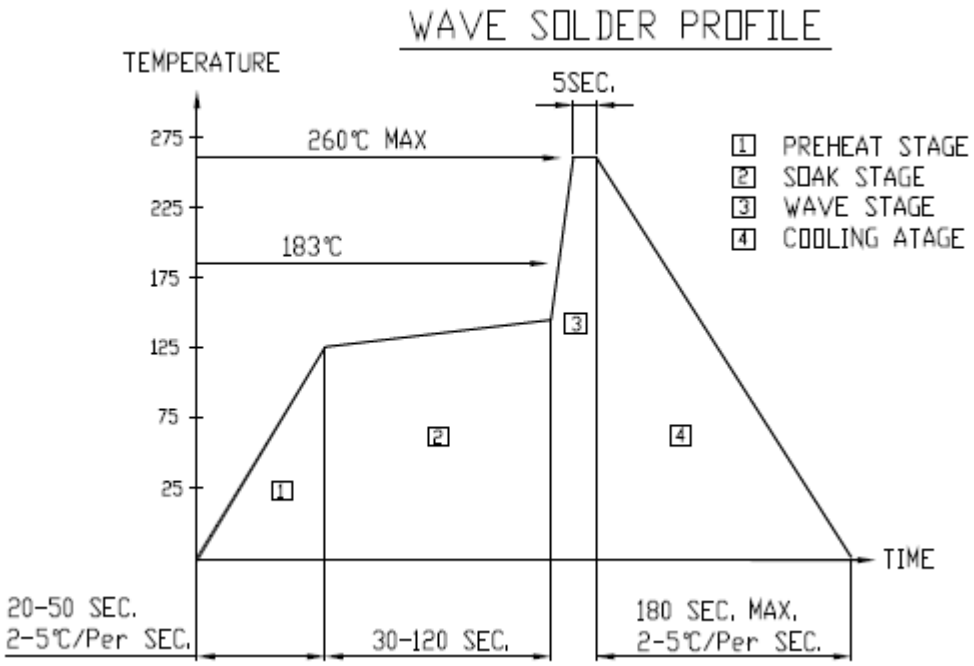


Fig.6 MAX. ALLOWABLE DC CURRENT VS. AMBIENT TEMPERATURE

Reflow Soldering



Soldering Iron

Basic Spec is ≦ 4 sec. when 260°C (+10°C ➔ -1 second). Power dissipation of Iron should be less than 15W. Surface temperature should be under 230°C

Rework

Rework should be completed within 4 second under 245°C

Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release for HNTD40		1.0	05-03-2013